Fast Acting Fuses

Fast-acting fuses help provide overcurrent protection on systems using DC power sources up to $63V_{DC}$. The fuse's monolithic, multilayer design provides the highest hold current in the smallest footprint, reduces diffusion-related aging, improves product reliability and resilience, and enhances high temperature performance. This helps facilitate the development of more reliable, high-performance consumer electronics such as laptops, multimedia devices, cell phones, and other portable electronics.



Benefits

- Small size with high current ratings
- · Excellent temperature stability
- · High reliability and resilience
- Strong arc suppression characteristics

Features

- RoHS compliant
- · Monolithic, multilayer design
- · High temperature performance
- -55°C to +125°C operating range

Applications

- Laptops
- · Digital cameras
- · Cell phones

- Printers
- · DVD players
- · Portable electronics

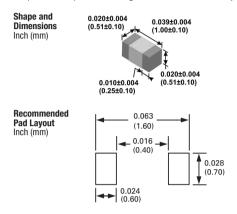
- · Game systems
- · LCD monitors
- Scanners

Table FF1 - Clear Time Characteristics for Fast Acting Fuses

% of rated current	Clear time at 25°C	
100%	4 hours min.	
250%	5 seconds max.	
400%	0.05 seconds max.	

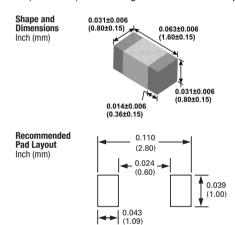
Table FF2 - Typical Electrical Characteristics, Demensions and Recommended Pad Layout for Fast Acting Fuses

0402 (1005mm) Fast Acting Surface-mount Chip Fuses



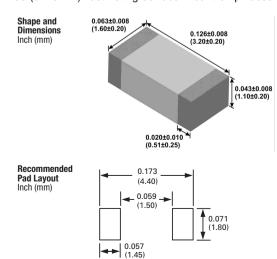
Part Number	Typical Electrical Characteristics*		Max Interrupt Ratings*	
	Rated Current (A)	Nominal Cold DCR †	Voltage (V _{DC})	Current (A)
0402SFF050F/24	0.50	0.380		
0402SFF075F/24	0.75	0.210		
0402SFF100F/24	1.00	0.120		
0402SFF150F/24	1.50	0.056	24	35
0402SFF200F/24	2.00	0.035		
0402SFF300F/24	3.00	0.021		
0402SFF400F/24	4.00	0.014		

0603 (1608mm) Fast Acting Surface-mount Chip Fuses



Part Number		Typical Electrical Characteristics*		Max Interrupt Ratings*	
	Rated Current (A)	Nominal Cold DCR † (Ω)	Voltage (V _{DC})	Current (A)	
0603SFF050F/32	0.50	0.485			
0603SFF075F/32	0.75	0.254		50	
0603SFF100F/32	1.00	0.131	32		
0603SFF150F/32	1.50	0.059			
0603SFF200F/32	2.00	0.044			
0603SFF250F/32	2.50	0.032			
0603SFF300F/32	3.00	0.025		0.5	
0603SFF350F/32	3.50	0.024		35	
0603SFF400F/32	4.00	0.018			
0603SFF500F/32	5.00	0.013			
0603SFF600F/24	6.00	0.010	24		

1206 (3216mm) Fast Acting Surface-mount Chip Fuses

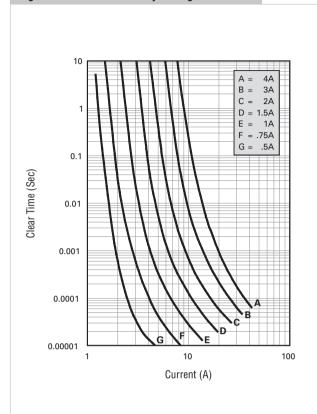


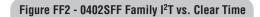
Part Number	Typical Electrical Characteristics*			lax t Ratings*
	Rated Current (A)	Nominal Cold DCR † (Ω)	Voltage (V _{DC})	Current (A)
1206SFF050F/63	0.50	0.500		
1206SFF075F/63	0.75	0.330		
1206SFF100F/63	1.00	0.220	63	50
1206SFF150F/63	1.50	0.120		
1206SFF175F/63	1.75	0.100		
1206SFF200F/63	2.00	0.050		
1206SFF250F/32	2.50	0.035		
1206SFF300F/32	3.00	0.031	32	
1206SFF400F/32	4.00	0.022		
1206SFF500F/32	5.00	0.015		
1206SFF600F/24	6.00	0.013		45
1206SFF700F/24	7.00	0.011	24	
1206SFF800F/24	8.00	0.008		
1206SFF800F/24 * Measured at 25°C	8.00	0.008		

[†] Measured at 10% of rated current

Figures FF1-FF6 - Family Average Clear Time

Figure FF1 - 0402SFF Family Average Clear Time





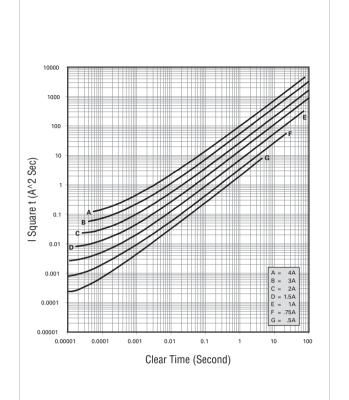


Figure FF3 - 0603SFF Family Average Clear Time

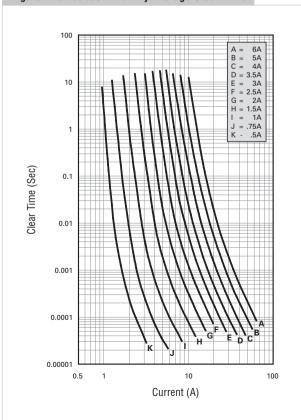
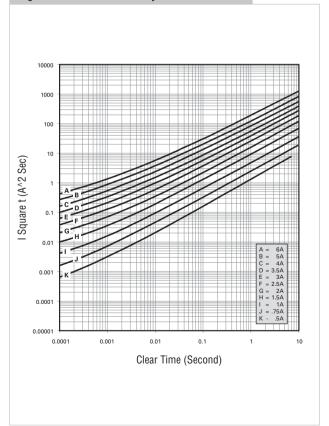
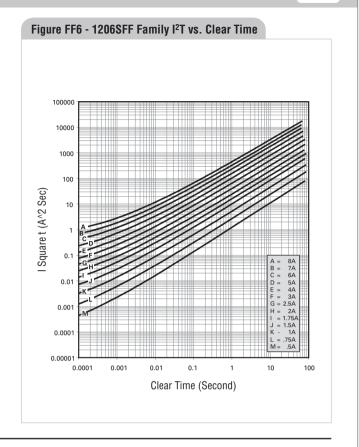


Figure FF4 - 0603SFF Family I²T vs. Clear Time



Current (A)



Environmental Specifications

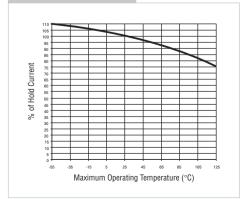
0.5

Operating Temperature	-55°C to +125°C
Mechanical Vibration	Withstands 5-3000 Hz at 30 Gs when evaluated per Method 204 of MIL-STD-202
Mechanical Shock	Withstands 1500 Gs, 0.5 millisecond half-sine pulses when evaluated per Method 213 of MIL-STD-202
Thermal Shock	Withstands 100 cycles from -65°C to +125°C when evaluated per Method 107 of MIL-STD-202
Resistance to Soldering Heat	Withstands 60 seconds at +260°C when evaluated per Method 210 of MIL-STD-202
Solderbility	Meets 95% minimum coverage requirement when evaluated per Method 208 of MIL-STD-202
Moisture Resistance	Withstands 10 cycles when evaluated per Method 106 of MIL-STD-202
Salt Spray	Withstands 48-hour exposure when evaluated per Method 101 of MIL-STD-202

Material Specifications

Construction Body Material	Ceramic
Termination Material	Silver, Nickel, Tin
Fuse Element	Silver
Terminal Strength	Hanging test: 0603: 0.5kg 30 seconds; 1206 1.5kg, 30 seconds; 0402 part types meet 2-pound push test

Thermal Derating Current



Electrical Specifications

Insulation Resistance after Opening	20,000Ω minimum @ rated voltage. Fuse clearing under low voltage conditions may result in lower part clearing insulation values. Under page 15 out
	post-clearing insulation values. Under normal fault conditions values. Under normal fault conditions Raychem fuses provide sufficient insulation
Current Carrying Capacity	resistance for circuit protection. Withstands 100% rated current at +25°C
, , , , , , , , , , , , , , , , , , , ,	ambient for 4 hours when evaluated per
	MIL-PRF-23419

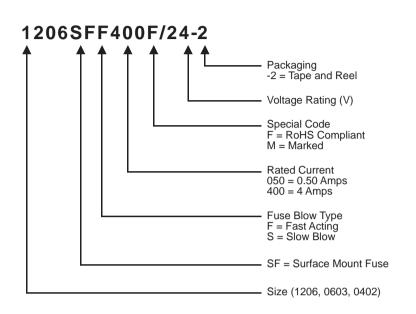
Packaging Specifications

Chip Size	Parts on 7-inch (178 mm) Reel	
0402 (1005)	10,000	
0603 (1608)	4,000	
1206 (3216)	3,000	

Agency Approvals for Fast Acting Fuses

UL File # E197536

Part Numbering System for Fast Acting Fuses





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